

SN54LS348, SN74LS348 (TIM9908) 8-LINE TO 3-LINE PRIORITY ENCODERS WITH 3-STATE OUTPUTS

SDLS161 – OCTOBER 1976 – REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include:
N-Bit Encoding
Code Converters and Generators
- Typical Data Delay . . . 15 ns
- Typical Power Dissipation . . . 60 mW

description

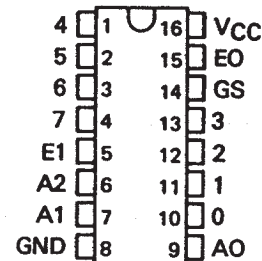
These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output EO) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

FUNCTION TABLE

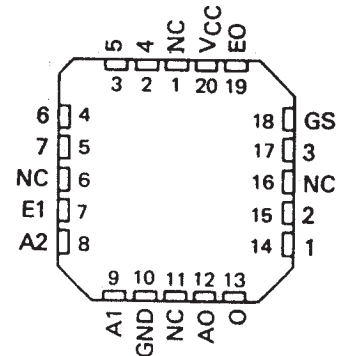
EI	INPUTS								OUTPUTS				
	0	1	2	3	4	5	6	7	A2	A1	A0	GS	EO
H	X	X	X	X	X	X	X	X	Z	Z	Z	H	H
L	H	H	H	H	H	H	H	H	Z	Z	Z	H	L
L	X	X	X	X	X	X	X	L	L	L	L	L	H
L	X	X	X	X	X	L	H	H	L	H	L	L	H
L	X	X	X	X	L	H	H	H	L	H	H	L	H
L	X	X	X	L	H	H	H	H	H	L	L	L	H
L	X	X	L	H	H	H	H	H	H	L	H	L	H
L	X	L	H	H	H	H	H	H	H	H	L	L	H
L	L	H	H	H	H	H	H	H	H	H	H	L	H

H = high logic level, L = low logic level, X = irrelevant
Z = high-impedance state

SN54LS348 . . . J OR W PACKAGE
SN74LS348 . . . D OR N PACKAGE
(TOP VIEW)

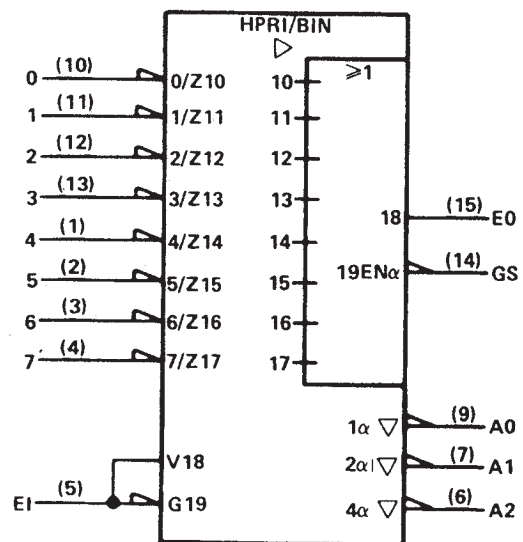


SN54LS348 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

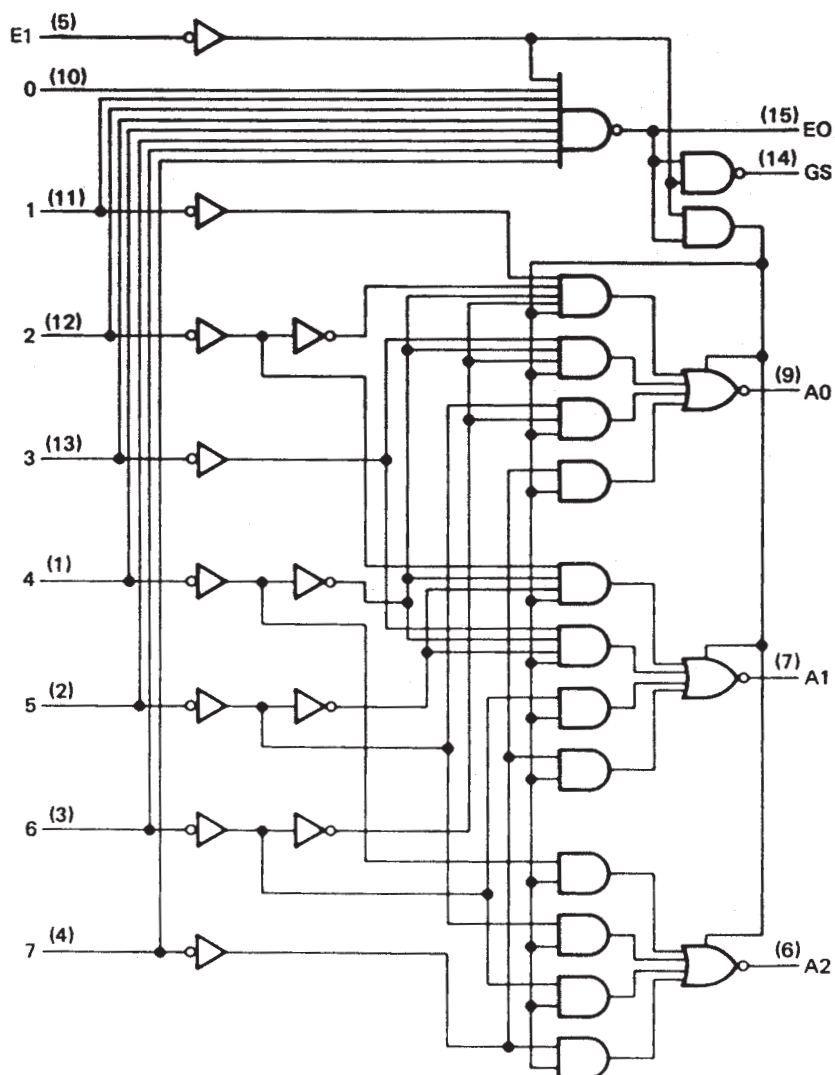
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8-LINE TO 3-LINE PRIORITY ENCODERS

WITH 3-STATE OUTPUTS

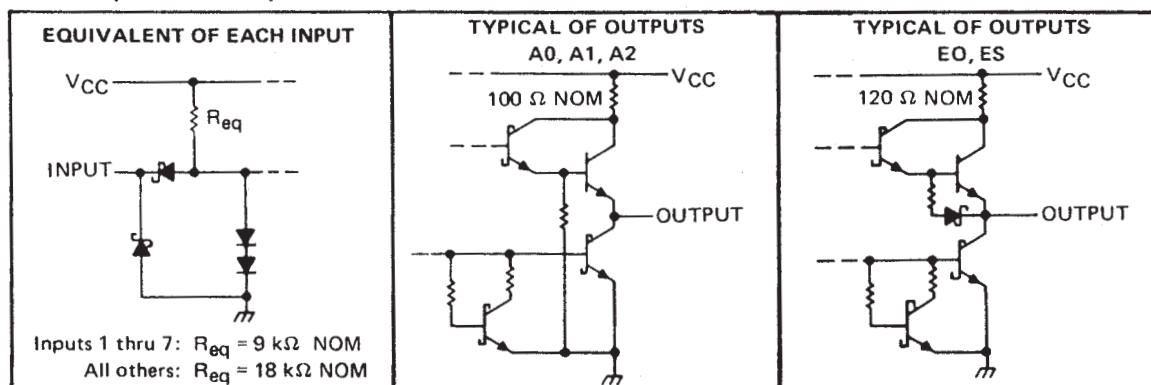
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logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematic of inputs and outputs



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8-LINE TO 3-LINE PRIORITY ENCODERS

WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	7 V
Operating free-air temperature range: SN54LS348	–55°C to 125°C
SN74LS348	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS348			SN74LS348			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}	A0, A1, A2	–1			–2.6			mA
	EO, GS	–400			–400			μA
Low-level output current, I_{OL}	A0, A1, A2	12			24			mA
	EO, GS	4			8			mA
Operating free-air temperature, T_A		–55	125		0	70		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS348		SN74LS348		UNIT	
				MIN	TYP‡	MAX	MIN		TYP‡
V_{IH}	High-level input voltage			2		2		V	
V_{IL}	Low-level input voltage			0.7		0.8		V	
V_{IK}	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$		-1.5		-1.5		V	
V_{OH}	High-level output voltage	A0, A1, A2	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$	$I_{OH} = -1 \text{ mA}$	2.4	3.1		V	
				$I_{OH} = -2.6 \text{ mA}$			2.4		3.1
		EO, GS	$V_{IL} = V_{IL\text{max}}$	$I_{OH} = -400 \mu\text{A}$	2.5	3.4	2.7		3.4
V_{OL}	Low-level Output voltage	A0, A1, A2	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$	$I_{OL} = 12 \text{ mA}$	0.25	0.4	0.25	0.4	V
				$I_{OL} = 24 \text{ mA}$			0.35	0.5	
				$I_{OL} = 4 \text{ mA}$	0.25	0.4	0.25	0.4	
		EO, GS	$V_{IL} = V_{IL\text{max}}$	$I_{OL} = 8 \text{ mA}$			0.35	0.5	
I_{OZ}	Off-State (high-impedance state) output current	A0, A1, A2	$V_{CC} = \text{MAX}, V_{IH} = 2 \text{ V}$	$V_O = 2.7 \text{ V}$	20		20	μA	
				$V_O = 0.4 \text{ V}$	-20		-20		
I_I	Input current at maximum input voltage	Inputs 1 thru 7	$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$		0.2		0.2	mA	
		All other inputs			0.1		0.1		
I_{IH}	High-level input current	Inputs 1 thru 7	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$		40		40	μA	
		All other inputs			20		20		
I_{IL}	Low-level input current	Inputs 1 thru 7	$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$		-0.8		-0.8	mA	
		All other inputs			-0.4		-0.4		
I_{OS}	Short-circuit output current§	Outputs A0, A1, A2	$V_{CC} = \text{MAX}$		-30	-130	-30	-130	mA
		Outputs EO, GS			-20	-100	-20	-100	
I_{CC}	Supply current		$V_{CC} = \text{MAX},$	Condition 1	13	25	13	25	mA
			See Note 2	Condition 2	12	23	12	23	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} (condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open. I_{CC} (condition 2) is measured with all inputs and outputs open.



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PARAMETER†	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
tPLH	1 thru 7	A0, A1, or A2	In-phase output	C _L = 45 pF, R _L = 667 Ω, See Note 3		11	17	ns	
tPHL						20	30		
tPLH	1 thru 7	A0, A1, or A2	Out-of-phase output			23	35	ns	
tPHL						23	35		
tPZH	EI	A0, A1, or A2				25	39	ns	
tPZL						24	41		
tPLH	0 thru 7	EO	Out-of-phase output	C _L = 15 pF R _L = 2 kΩ, See Note 3		11	18	ns	
tPHL						26	40		
tPLH	0 thru 7	GS	In-phase output			38	55	ns	
tPHL						9	21		
tPLH	EI	GS	In-phase output			11	17	ns	
tPHL						14	36		
tPLH	EI	EO	In-phase output			17	26	ns	
tPHL						25	40		
tPHZ	EI	A0, A1, or A2		C _L = 5 pF R _L = 667 Ω		18	27	ns	
tPLZ						23	35		

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

The diagram illustrates a 3-stage cascaded 'LS348 8-bit DAC configuration, capable of outputting up to 64 lines. The top three stages are connected in a chain, with the MSB of one stage connected to the LSB of the next. The bottom stage is connected to the MSB of the top stage. The output lines are labeled from 0 to 7 for each stage, with the top stage's output being the MSB and the bottom stage's output being the LSB. The diagram shows the internal structure of the 'LS348, including the A0, A1, A2, and GS inputs, and the EO and EI outputs. The bottom stage's EI is connected to ground, and its GS output is labeled 'STROBE OUTPUT'.

FIGURE 1—PRIORITY ENCODER WITH UP TO 64 INPUTS.

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